| | | | | | | | | F | REVIS | IONS | | | | | | | | | | |
|--|-----------------|---|-------------------------|----------|-----------------|------------------|--------------|--------|--------|---------|---------|----------------|------|---------|---------|--------|-------|---------|---------|------|
| LTR | | | | | C | DESCR | IPTIO | N | | | | | D | ATE (Y | 'R-MO-I | DA) | | APPI | ROVE | D |
| A | Add | | locume backag it. | | | | | | | | 06. | | | 91-0 | 8-23 | | M. A | A. Frye | 9 | |
| В | | | oilerpla hrough | | dd dev | ice typ | e 07 f | or ven | dor 66 | 675. | Editori | ial | | 94-0 | 7-12 | | M. A | A. Frye | 9 | |
| С | | | e type: hrough | | nrough | 10. L | Jpdate | boiler | plate. | Edito | rial | | | 95-0 | 5-12 | | M. A | A. Frye | | |
| D | Add | devic | e types | s 11 th | nrough | 14. L | Jpdate | boiler | plate. | ksr | | | | 98-1 | 2-04 | | Ray | mond | Monni | in |
| E | | Changes throughout. Add device types 11 through 14. Update boilerpla Lower tPD and tCO minimum value by 1 ns for dev 03. ksr | | | | | | | | es 01, | 02, ar | nd | | 99-0 | 8-04 | | R | aymoi | nd Moi | nnin |
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| DEPA AND AGEI DEPARTMEI | | OF TH | | | 18 | G APP Decen | nber 1 | | E | SIZE | - | | E CO | | | 59 | 62- | .89 | 839 |) |
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| | | | | | | I | Ξ | | | SHE | ET | 1 | | OF | 13 | | | | | |

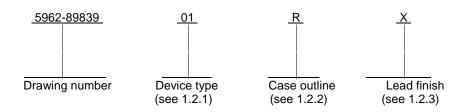
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DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.



1.1 <u>Scope</u>. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A.

1.2 Part or Identifying Number (PIN). The complete PIN shall be as shown in the following example:



1.2.1 <u>Device type(s)</u>. The device type(s) shall identify the circuit function as follows:

| Device type | <u>Generic number</u> | Circuit function | | Access tim | Supply e <u>current</u> |
|--------------------|-----------------------------------|---|------------------|---|----------------------------|
| 01 | 16V8 | 16-input, 8-output, EE generic, programmab | | urally 30 | 130 |
| 02 | 16V8 | 16-input, 8-output, EE generic, programmab | | urally 20 | 130 |
| 03 | 16V8 | 16-input, 8-output, EE generic, programmab | | urally 15 | 130 |
| 04, 11 | 16V8 | 16-input, 8-output, EE generic, programmab | | urally 10 | 130 |
| 05 | 16V8 | 16-input, 8-output, EE generic, programmab | | urally 25 | 65 |
| 06 | 16V8 | 16-input, 8-output, EE generic, programmab | | urally 20 | 65 |
| 07 | 16V8 | 16-input, 8-output, EE generic, programmab | | urally 7.5 | 130 |
| 08, 12 | 16V8 | 16-input, 8-output, EE generic, programmab | | urally 25 | 65 |
| 09, 13 | 16V8 | 16-input, 8-output, EE generic, programmab | | urally 15 | 130 |
| 10, 14 | 16V8 | 16-input, 8-output, EE generic, programmab | | urally 15 | 65 |
| 1.2.2 Case outlin | <u>e(s)</u> . The case outli | ne(s) shall be as design | ated in MIL-STD- | 1835 and as follows: | |
| Outline let | ter Descriptive | designator <u>Ter</u> | rminals | Package style | |
| R S 2 | | or CDIP2-T20) or CDFP3-F20 0 | 20 20 20 | Dual-in-line Flat package Square chip carri | er package |
| 1.2.3 Lead finish. | The lead finish is a | as specified in MIL-PRF- | -38535, appendix | Α. | |
| MIC | STANDARD CROCIRCUIT DRAV | VING | SIZE A | | 5962-89839 |
| DEFENSE | SUPPLY CENTER JMBUS, OHIO 4231 | COLUMBUS | | REVISION LEVEL E | SHEET 2 |

1.3 Absolute maximum ratings.

| Supply voltage range | -0.5 V dc to +7.0 V dc -2.5 V dc to V_{CC} + 1.0 V dc <u>1</u> / -2.5 V dc to V_{CC} + 1.0 V dc <u>1</u> / -65°C to +150°C 1.5 W +260°C See MIL-STD-1835 +175°C 10 years (minimum) 100 erase/write cycles (minimum) |
|--|--|
| $\label{eq:recommended operating conditions} \\ \begin{tabular}{lllllllllllllllllllllllllllllllllll$ | 4.5 V dc to 5.5 V dc 2.0 V dc to V _{CC} + 1.0 V dc V _{SS} -0.5 V dc to +0.8 V dc -2.0 mA maximum 12 mA maximum |
| Case operating temperature range (T_C) | -55°C to +125°C |

2. APPLICABLE DOCUMENTS

2.1 <u>Government specification, standards, and handbooks</u>. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation.

SPECIFICATION

1

DEPARTMENT OF DEFENSE

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

STANDARDS

DEPARTMENT OF DEFENSE

MIL-STD-883- Test Method Standard Microcircuits.MIL-STD-973- Configuration Management.MIL-STD-1835- Interface Standard For Microcircuit Case Outlines.

HANDBOOKS

DEPARTMENT OF DEFENSE

MIL-HDBK-103 - List of Standard Microcircuit Drawings (SMD's). MIL-HDBK-780 - Standard Microcircuit Drawings.

(Unless otherwise indicated, copies of the specification, standards, and handbooks are available from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 <u>Order of precedence</u>. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

 $\frac{1}{2}$ Minimum input voltage is -0.5 V dc which may undershoot to -2.5 V dc for pulses less than 20 ns. $\frac{2}{2}$ Must withstand the added P_D due to short circuit test, e.g., I_{OS}.

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| | т | ABLE I. Electrical performance cha | racteristics | | | | |
|---|--------------------|--|---------------------------|----------------|-------------------------|-------------------------|------|
| Test | Symbol | | Device | Group A | Limi | ts | Unit |
| | | $\begin{array}{l} -55^\circ C \leq T_C \leq +125^\circ C \\ V_{SS} = 0 \ V, \ 4.5 \ V \leq V_{CC} \leq 5.5 \ V \\ \hline unless \ otherwise \ specified \end{array}$ | type | sub- groups | Min | Мах | |
| Input leakage current | I _{LX} | $0.0 \ V \ \le \ V_{IN} \ \le \ V_{CC}$ | 01-03, 05,06 | 1,2,3 | -10 | 10 | μA |
| | | | 04, 07-14 | | -100 | 10 | |
| Bidirectional pin leakage current | I _{I/O/Q} | $0.0 \ V \ \leq \ V_{I/O/Q} \ \leq \ V_{CC}$ | 01-03, 05,06 | 1,2,3 | -10 | 10 | μA |
| | | | 04, 07-14 | | -100 | 10 | |
| Output low voltage | VOL | V_{CC} = 4.5 V, I_{OL} = 12 mA, V _{IN} = V _{IH} or V _{IL} | All | 1,2,3 | | 0.5 | V |
| Output high voltage | VOH | V_{CC} = 4.5 V, I _{OH} = -2.0 mA, V _{IN} = V _{IH} or V _{IL} | All | 1,2,3 | 2.4 | | V |
| Input low voltage <u>1</u> / | VIL | | All | 1,2,3 | V _{SS} -0.5 | 0.8 | V |
| Input high voltage <u>1</u> / | VIH | | All | 1,2,3 | 2.0 | V _{CC} +1.0 | V |
| Operating power supply current <u>2</u> / | ICC | V _{IL} = 0.5 V, V _{IH} = 3.0 V, f _{tog} = 25 MHz | 01-04, 07,09, 11,13 | 1,2,3 | | 130 | mA |
| | | | 05,06, 08,10, 12,14 | | | 65 | |
| Output short circuit current <u>3</u> / | IOS | $V_{CC} = 5.0 \text{ V}, V_{OUT} = 0.5 \text{ V}, T_A = +25^{\circ}\text{ C}, \text{ see } 4.3.1\text{ d}$ | All | 1 | -30 | -150 | mA |
| Input capacitance | C _{IN} | $V_{CC} = 5.0 \text{ V}, V_I = 2.0 \text{ V}, f = 1.0 \text{ MHz}, T_A = +25^{\circ}\text{ C}, see 4.3.1c$ | All | 4 | | 10 | pF |
| Bidirectional pin capacitance | C _{I/O/Q} | $V_{CC} = 5.0 \text{ V}, V_{I/O/Q} = 2.0 \text{ V},$ f = 1.0 MHz, T _A = +25°C, see 4.3.1c | All | 4 | | 10 | pF |
| Functional tests | | See 4.3.1e | All | 7,8A,8B | | | |

See footnotes at end of table.

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| Test | Symbol | Conditions | Device | Group A | Limite | <u> </u> | Unit |
|---|------------------|--|--------------------------|----------------|-------------------|-----------------|----------|
| | | $\begin{array}{l} -55^{\circ}C \leq T_C \leq +125^{\circ}C \\ V_{SS} = 0 \text{ V}, \ 4.5 \text{ V} \leq V_{CC} \leq 5.5 \text{ V} \\ \text{unless otherwise specified} \end{array}$ | type | sub- groups | Min | Max | |
| nput or feedback to nonregistered output | ^t PD | $V_{CC} = 4.5 V$, see figures 3 and 4 <u>4</u> / | 01 | 9,10,11 | 2.0 | 30 | ns |
| | | | 02 | - | 2.0 | 20 | - |
| | | | <u>06</u> 03 | - | <u>3.0</u> 2.0 | <u>20</u> 15 | - |
| | | | 09,10, 13,14 | - | 3.0 | 15 | - |
| | | | 04 | _ | 2.0 | 10 | _ |
| | | | 05,08, 12 | | 3.0 | 25 | |
| | | | 07 | - | 1.0 | 7.5 | - |
| | | | 11 | | 3.0 | 10.0 | |
| Clock to output delay | tCO | | 01 | 9,10,11 | 1.0 | 20 | ns |
| <u>5</u> / | | | 02 | - | 1.0 | 15 15 | - |
| | | | 06 | _ | 2.0 | 15 | - |
| | | | 03 | - | 2.0 | 12 | - |
| | | | 04 | - | 1.0 | 7.0 | _ |
| | | | <u>13,14</u> 05,08 | - | <u>2.0</u> 2.0 | 10.0 15 | - |
| | | | 07 | - | 1.0 | 6 | _ |
| | | | 11 | | 2.0 | 7.0 | |
| nput to output enable | ^t EA1 | | 01 | 9,10,11 | | 30 | ns |
| | | | 02,06 | - | | 20 | - |
| | | | 03,09, 10,13,14 | | | 15 | _ |
| | | | 04,11 | - | | 10 | - |
| | | | 05,08, | - | | 25 | - |
| | | | <u>12</u> 07 | - | | 9.0 | - |
| nput to output register | t _{EA2} | | 01,08 | 9,10,11 | | 25 | ns |
| enable <u>5</u> / | | | 02,06 | - | <u> </u> | 18 | - |
| | | | 03,09, | - | <u> </u> | 15 | - |
| | | | <u>10,13,14</u> 04,11 | - | | 10 | - |
| | | | 05,12 | - | | 20 | - |
| | | | 07 | - | <u> </u> | 7.0 | - |
| See footnotes at end of table. | | ł | <u> </u> | <u> </u> | | - | <u> </u> |
| STAN | IDARD | SIZE A | | | | 596 | 2-898 |
| MICROCIRC | JIT DRAW | 'ING | | | | | _ |
| DEFENSE SUPPLY (COLUMBUS, O | | | REVI | SION LEVE E | EL | SHEET | 「 5 |

| Test | Symbol | Conditions | Device | Group A | Limit | S | Unit |
|--|-------------------|--|--------------------------|----------------|-------|--------------|-------|
| | | $\begin{array}{l} -55^\circ C \ \leq \ T_C \ \leq \ +125^\circ C \\ V_{SS} = 0 \ V, \ 4.5 \ V \ \leq \ V_{CC} \ \leq \ 5.5 \ V \\ \hline unless \ otherwise \ specified \end{array}$ | type | sub- groups | Min | Max | |
| Input to output disable <u>6</u> / | ^t ER1 | $V_{CC} = 4.5 V$, see figures 3 and 4 <u>4</u> / | 01 | 9,10,11 | | 30 | ns |
| | | | 02,06 | | | 20 | |
| | | | 03,09, 10,13,14 | - | | 15 | |
| | | | 04,11 | - | | 10 | |
| | | | 05,08, | - | | 25 | |
| | | | <u>12</u> 07 | - | | 7.0 | |
| nput to output register disable <u>5</u> / <u>6</u> / | ^t ER2 | | 01,08 | 9,10,11 | | 25 | ns |
| | | | 02,06 | - | | 18 | - |
| | | | 03,09, | - | | 15 | |
| | | | <u>10,13,14</u> 04,11 | - | | 10 | - |
| | | | 05,12 | - | | 20 | |
| | | | 07 | - | | 7.0 | |
| Clock frequency without | fCLK1 | | 01 | 9,10,11 | 0.0 | 33.3 | MHz |
| feedback <u>5/ 7/</u> | OLIVI | | <u>12</u> 02,06 | - | 0.0 | 37.0 41.6 | · |
| | | | 13,14 | - | 0.0 | 45.5 | |
| | | | 03,09, 10 | | 0.0 | 50.0 | |
| | | | 04 | - | 0.0 | 62.5 | • |
| | | | <u>11</u> 05,08 | - | 0.0 | 58.0 33.3 | |
| | | | 07 | - | 0.0 | 100.0 | |
| Clock frequency with | fCLK2 | | 01 | 9,10,11 | 0.0 | 22.2 | MHz |
| feedback <u>5</u> / | | | 02,06 | | 0.0 | 33.3 | |
| | | | 12 | - | 0.0 | 40.0 | |
| | | | 03,09, 10 | _ | 0.0 | 41.6 | |
| | | | 04 | - | 0.0 | 58.5 50.0 | |
| | | | 05,08 | - | 0.0 | 28.5 | |
| | | | <u>11</u> 07 | - | 0.0 | 62.5 76.9 | - |
| See footnotes at end of table. | | | 01 | | 0.0 | 10.5 | |
| | | SIZE | | | | | |
| STAN MICROCIRCI | IDARD JIT DRAW | | | | | 5962 | 2-898 |
| DEFENSE SUPPLY (COLUMBUS, O | CENTER C | OLUMBUS | REVISION LEVEL SHE | | | SHEET | - |

| Test | Symbol | Conditions | Device | Group A | Limits | | Unit |
|---|------------------|--|---------------------------|----------------|--------|-----|------|
| | | $\begin{array}{l} -55^\circ C \ \leq \ T_C \ \leq \ +125^\circ C \\ V_{SS} = 0 \ V, \ 4.5 \ V \ \leq \ V_{CC} \ \leq \ 5.5 \ V \\ \text{unless otherwise specified} \end{array}$ | type | sub- groups | Min | Max | |
| Input or feedback setup | t _S | V_{CC} = 4.5 V, see figures | 01 | 9,10,11 | 25 | | ns |
| time, before rising clock <u>5</u> / | C | 3 and 4 <u>4</u> / | 02,06, 12 | | 15 | | |
| | | | 03,09, 10,13,14 | | 12 | | _ |
| | | | 04,11 | | 10 | | |
| | | | 05,08 | • | 20 | | _ |
| | | | 07 | | 7.0 | | _ |
| Input or feedback hold time | tн | | 01 - 10 | 9,10,11 | 0 | | ns |
| after rising clock <u>5</u> / | | | <u>11 - 14</u> | | 0.5 | | |
| Clock pulse width, high 5/ | ^t PWH | | 01 | 9,10,11 | 15 | | ns |
| | | | 02,06, 12 | | 12 | | |
| | | | 03,09, | | 10 | | - |
| | | | 04,13,14 | | 8.0 | | - |
| | | | 05,08 | | 15 | | - |
| | | | 07 | | 5.0 | | _ |
| | | | 11 | | 6.0 | | |
| Clock pulse width, low 5/ | ^t PWL | | 01 | 9,10,11 | 15 | | ns |
| | | | 02,06, 12 | | 12 | | |
| | | | 03,09, | • | 10 | | - |
| | | | <u>10</u> 04,13, 14 | | 8.0 | | - |
| | | | 05,08 | • | 15 | | - |
| | | | 07 | | 5.0 | | - |
| | | | 11 | • | 6.0 | 1 | - |

1/ These are absolute values with respect to device ground, and all overshoots due to system or tester noise are included.

2/ This parameter may be tested at a frequency other than 25MHz, but shall be guaranteed to the specified limits at 25MHz.

3/ Not more than one output at a time should be shorted. Short circuit test duration should not exceed 1 second (see 4.3.1d).

4/ AC tests are performed with input rise and fall times (10 percent to 90 percent) of 3.0 ns, timing reference levels of 1.5 V, input pulse levels of 0 to 3.0 V and the output load of figure 3. Input pulse levels are absolute values with respect to device ground, and all overshoots due to system or tester noise are included.

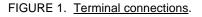
5/ Test applies only to registered outputs.

 $\overline{6}$ / Transition is measured at steady-state high level -500 mV or steady-state low level +500 mV on the output from the 1.5 V level on the input.

<u>7</u>/ Tested initially and after any design or process changes that affect that parameter, and therefore shall be guaranteed to the limits specified in table I.

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|---|-----------|---------------------|-------------------|
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| Device types | All |
|---|--|
| Case outlines | R, S, and 2 |
| Terminal number | Terminal symbol |
| 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20 | I/CLK I I I I I GND I/OE I/O/Q |



| | Inputs | | | | | | | | | | Outputs | | | | | | | |
|----------------------------------|--------|---|---|---|---|---|---|------|-----|-----------------|-------------------|------------------|--------|-------|-------|-------|---------|--|
| /CLK | I/ŌE | I | I | I | I | I | I | I | I | I/O/Q | I/O/Q | I/O/Q | I/O/Q | I/O/Q | I/O/Q | I/O/Q | I/O/Q | |
| Х | х | x | х | х | х | х | х | х | х | н | н | н | н | н | н | н | н | |
| | c high | | | | | | | FIGI | JRE | 2. <u>Truth</u> | <u>i table (u</u> | nprogran | nmed). | | | | | |
| STANDARD MICROCIRCUIT DRAWING | | | | | | | | | | | | SIZE A | | | | 5 | 962-898 | |

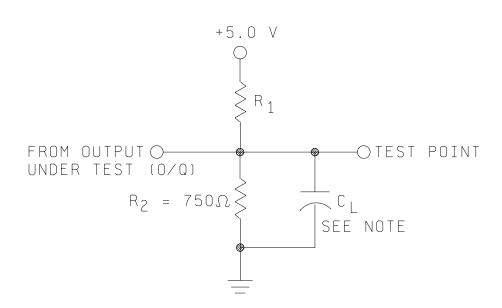
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SHEET

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MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 42316-5000



| Test | R ₁ | CL (minimum) |
|---|--|-----------------|
| ^t PD, t _{CO} , f _{CLK1} , f _{CLK2} | 390Ω | 50 pF |
| ^t EA1 ^{, t} EA2 | Active high = infinity Active low = 390Ω | 50 pF |
| ^t ER1 ^{, t} ER2 | Active high = infinity Active low = 390Ω | 5.0 pF |

NOTE: C_L = load capacitance and includes jig and probe capacitance.

FIGURE 3. Output load circuit.

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|----------------------------------|------------------|----------------|------------|
| DEFENSE SUPPLY CENTER COLUMBUS | | REVISION LEVEL | SHEET |
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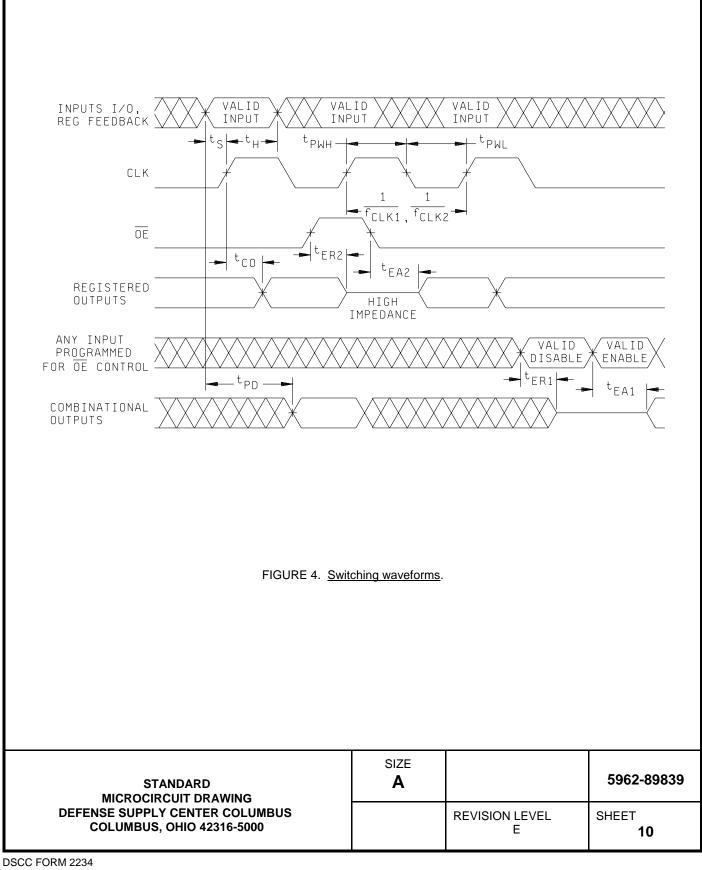


TABLE II. Electrical test requirements.

| MIL-STD-883 test requirements | Subgroups (in accordance with method 5005, table I) |
|---|---|
| Interim electrical parameters (method 5004) | |
| Final electrical test parameters (method 5004) | 1*,2,3,7*,8A, 8B,9,10,11 |
| Group A test requirements (method 5005) | 1,2,3,4**,7,8A, 8B,9,10,11 |
| Group C and D end-point electrical parameters (method 5005) | 2,3,7,8A,8B |

* PDA applies to subgroups 1 and 7.

** See 4.3.1c

3. REQUIREMENTS

3.1 <u>Item requirements</u>. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.

3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.

3.2.1 <u>Case outline(s)</u>. The case outline(s) shall be in accordance with 1.2.2 herein.

3.2.2 <u>Terminal connections</u>. The terminal connections shall be as specified on figure 1.

3.2.3 <u>Truth table (unprogrammed devices)</u>. The truth table for unprogrammed devices shall be as specified on figure 2.

3.2.4 <u>Programmed devices</u>. The requirements for supplying programmed devices are not a part of this drawing.

3.3 <u>Electrical performance characteristics</u>. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full case operating temperature range.

3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

3.5 <u>Marking</u>. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked as listed in MIL-HDBK-103 (see 6.6 herein). For packages where marking of the entire SMD PIN is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device.

3.6 <u>Certificate of compliance</u>. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.

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3.7 <u>Certificate of conformance</u>. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 <u>Notification of change</u>. Notification of change to DSCC-VA shall be required in accordance with MIL-PRF-38535, appendix A.

3.9 <u>Verification and review</u>. DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

3.10 <u>Endurance</u> A reprogrammability test shall be completed as part of the vendor's reliability process. This reprogrammability test shall be done for initial characterization and after any design or process changes which may affect the reprogrammability of the device. The methods and procedures may be vendor specific, but shall guarantee the number of program/erase endurance cycles listed in section 1.3 herein. The vendor's procedure shall be under document control and shall be made available upon request.

3.11 <u>Retention</u> A data retention stress test shall be completed as part of the vendor's reliability monitors. This test shall be done for initial characterization and after any design or process changes which may affect data retention. The methods and procedures may be vendor specific, but shall guarantee the number of years listed in section 1.3 herein over the full military temperature range. The vendor's procedure shall be kept under document control and shall be made available upon request of the acquiring or preparing activity, along with the test data.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

- a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
 - (2) $T_A = +125^{\circ}C$, minimum.
 - (3) Devices shall be burned-in containing a pattern that assures all inputs and I/O's are dynamically switched. This pattern must have all cells programmed in a high or low state (not neutralized).
 - (4) The burn-in pattern shall be read before and after burn-in. Devices having any logic array bits not in the proper state shall constitute a device failure and shall be added as failures for PDA calculation.
- b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 <u>Quality conformance inspection</u>. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Subgroup 4 (C_{IN} and C_{I/O/Q} measurements) shall be measured only for the initial test and after process or design changes which may affect capacitance. Sample size is 15 devices with no failures, and all input and output terminals tested.
- d. I_{OS} measurements in subgroup 1 shall be measured only for the initial test and after process or design changes which may affect I_{OS}. Sample size is 15 devices with no failures, and all output terminals tested.
- e. Subgroups 7 and 8 shall include verification of the truth table.

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4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
 - (2) $T_A = +125^{\circ}C$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.
 - (4) All devices shall be programmed with a pattern that assures all inputs and I/O's are dynamically switched.

4.4 <u>Programming procedures</u>. The programming procedures shall be as specified by the device manufacturer and shall be made available to the user on request.

4.5 <u>Erasing procedures</u>. The erasing procedures shall be as specified by the device manufacturer and shall be made available to the user on request.

5. PACKAGING

5.1 <u>Packaging requirements</u>. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.

6. NOTES

6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-973 using DD Form 1692, Engineering Change Proposal.

6.4 <u>Record of users</u>. Military and industrial users shall inform Defense Supply Center Columbus when a system application requires configuration control and the applicable SMD. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0525.

6.5 <u>Comments</u>. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43216-5000, or telephone (614) 692-0674.

6.6 <u>Approved sources of supply</u>. Approved sources of supply are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

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STANDARD MICROCIRCUIT DRAWING SOURCE APPROVAL BULLETIN

DATE: PRELIMINARY 99-08-04

Approved sources of supply for SMD 5962-89839 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535.

| 1 | | |
|--|----------------------------------|--|
| Standard microcircuit drawing PIN <u>1</u> / | Vendor CAGE number | Vendor similar PIN <u>3</u> / |
| 5962-8983901RA | <u>2</u> / 66675 | PALCE16V8H-25E4/BRA GAL16V8D-30LD/883C |
| 5962-89839012A | <u>2/</u> <u>2</u> / | PALCE16V8H-25E4/B2A GAL16V8A-30LR/883C |
| 5962-8983902RA | <u>2/</u> <u>2</u> / 66675 | GAL16V8L20J/883 PALCE16V8H-20E4/BRA GAL16V8D-20LD/883C |
| 5962-89839022A | <u>2</u> / 66675 | PALCE16V8H-20E4/B2A GAL16V8D-20LR/883C |
| 5962-8983902SA | <u>2</u> / | GAL16V8L20W/883 |
| 5962-8983903RA | <u>2/</u> <u>2</u> / 66675 | GAL16V8L15J/883 PALCE16V8H-15E4/BRA GAL16V8D-15LD/883C |
| 5962-89839032A | <u>2</u> / 66675 | PALCE16V8H-15E4/B2A GAL16V8D-15LR/883C |
| 5962-8983903SA | <u>2</u> / | GAL16V8L15W/883 |
| 5962-8983904RA | 66675 <u>2</u> / 2/ | GAL16V8D-10LD/883C ATF16V8B-10GM/883 PALCE16V8-10DMB |
| 5962-89839042A | 66675 <u>2</u> / 2/ | GAL16V8D-10LR/883C ATF16V8B-10NM/883 PALCE16V8-10LMB |
| 5962-8983905RA | 2/ | GAL16V8A-25QD/883C |
| 5962-89839052A | <u>2</u> / | GAL16V8A-25QR/883C |
| 5962-8983906RA | <u>2</u> / | GAL16V8A-20QD/883C |
| 5962-89839062A | <u>2</u> / | GAL16V8A-20QR/883C |
| | | |

See footnote at end of list.

| Standard microcircuit drawing PIN <u>1</u> / | Vendor CAGE number | Vendor similar PIN <u>3</u> / |
|--|--------------------------|-------------------------------------|
| 5962-8983907RA | 66675 | GAL16V8D-7LD/883 |
| 5962-89839072A | 66675 | GAL16V8D-7LR/883 |
| 5962-8983908RA | <u>2</u> / | PALCE16V8L-25DMB |
| 5962-89839082A | <u>2</u> / | PALCE16V8L-25LMB |
| 5962-8983909RA | <u>2</u> / | PALCE16V8-15DMB |
| 5962-89839092A | <u>2</u> / | PALCE16V8-15LMB |
| 5962-8983910RA | <u>2</u> / | PALCE16V8L-15DMB |
| 5962-89839102A | <u>2</u> / | PALCE16V8L-15LMB |
| 5962-8983911RA | 65786 | PALCE16V8-10DMB |
| 5962-89839112A | 65786 | PALCE16V8-10LMB |
| 5962-8983912RA | 65786 | PALCE16V8L-25DMB |
| 5962-89839122A | 65786 | PALCE16V8L-25LMB |
| 5962-8983913RA | 65786 | PALCE16V8-15DMB |
| 5962-89839132A | 65786 | PALCE16V8-15LMB |
| 5962-8983914RA | 65786 | PALCE16V8L-15DMB |
| 5962-89839142A | 65786 | PALCE16V8L-15LMB |
| | 1 | |

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed, contact the vendor to determine 2/ This vendor number no longer available from an approved source.
 3/ Caution. Do not use this number for item acquisition.
- Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

| Vendor CAGE number | Vendor name and address |
|-----------------------|--|
| 66675 | Lattice Semiconductor Corporation 5555 NE Moore Court Hillsboro, OR 97124-6421 |
| 65786 | Cypress Semiconductor 3901 North First Street San Jose, CA 95134-1599 |

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in this information bulletin.